AGREEMENT TO ASSIGN

This Agreement To Assign ("**Agreement**") is made between <u>Ryan Oh</u> [NRIC/FIN No. <u>T0313655D</u>] ("**you**") and Temasek Polytechnic of 21 Tampines Avenue 1, Singapore 529757 ("**TP**").

It is agreed:

- In relation to your activities, work and participation in your educational course with TP, whether under the Student Internship Programme and/or Major Project, and/or TP's collaboration with a third party in any form whatsoever (not limited to TP's participation in a competition), and/or any other project at TP (referred to singularly and collectively as "**Project**"), you irrevocably assign, free from any encumbrance, to TP the following:
- (a) all your intellectual property rights in any works, designs and inventions, and in any forms of expression embodying such works, made by you, whether made solely by you or together with others, that may arise in connection with such Project; and
- (b) that such intellectual property rights assigned to TP shall include, without limitation, rights (i) worldwide; (ii) present and future; (iii) in any adaptation; (iv) to apply for and own patents, design registrations, copyrights, trade mark registrations or similar forms of protection worldwide; (v) to exploit the same in commerce or for public good; and (vi) to recover and take proceedings for infringement.
- The benefits from TP to you (as may be applicable) in consideration for the above assignment, which consideration you acknowledge to be sufficient, include the following:
- (a) TP's provision of education and coaching under the Project, and/or permitting your participation in the Project, being the practical part of your course of study, to allow you to learn the means to earn a livelihood; or
- (b) TP's provision of services in negotiating with third parties for places in the Project for TP's students generally, and/or provision of opportunity for its students to participate in TP's collaboration with a third party, and/or raising of fund; or
- (c) without any obligation, TP's consideration of the use and industrial application of the intellectual property concerned in commerce or for public good, and if so, TP's efforts to secure its protection, development, exploitation and market and/or rewarding you under any TP's prevailing policy, as may be changed by TP from time to time, or under any scheme as may be distributed by TP in TP's sole determination.
- 3 You undertake and agree:
- (a) that you will not grant nor agree to grant any intellectual property rights to any other party that conflicts with this Agreement; and
- (b) to give to TP any known information relating to any intellectual property rights to be assigned under this Agreement;
- (c) to sign such further documents and do all things necessary, as may be requested by TP, in order to confirm, perfect or give effect to the intended assignment under this Agreement; and
- (d) that the intellectual property rights to be assigned under this Agreement are neither defamatory nor libelous, and that they do not infringe the rights of any third party.
- This Agreement is binding on the parties' successors-in-title and assigns, as the case may be. Any delay or failure by TP to exercise any right shall not constitute a waiver. If any provision of this Agreement is held to be unenforceable, that provision shall be deemed to have been severed and the rest of this Agreement shall remain valid and enforceable. This Agreement is made under the laws of Singapore.

Signatory (Student)		Witness		
Name: Date:	Ryan Oh 15/09/2022	Name: Date:	Stanley Lu 15/09/2022	
Signed for and on behalf of Temasek Polytechnic		Witness		
Name:		Name:		
Designatio Date:	n:	Designation: Date:		